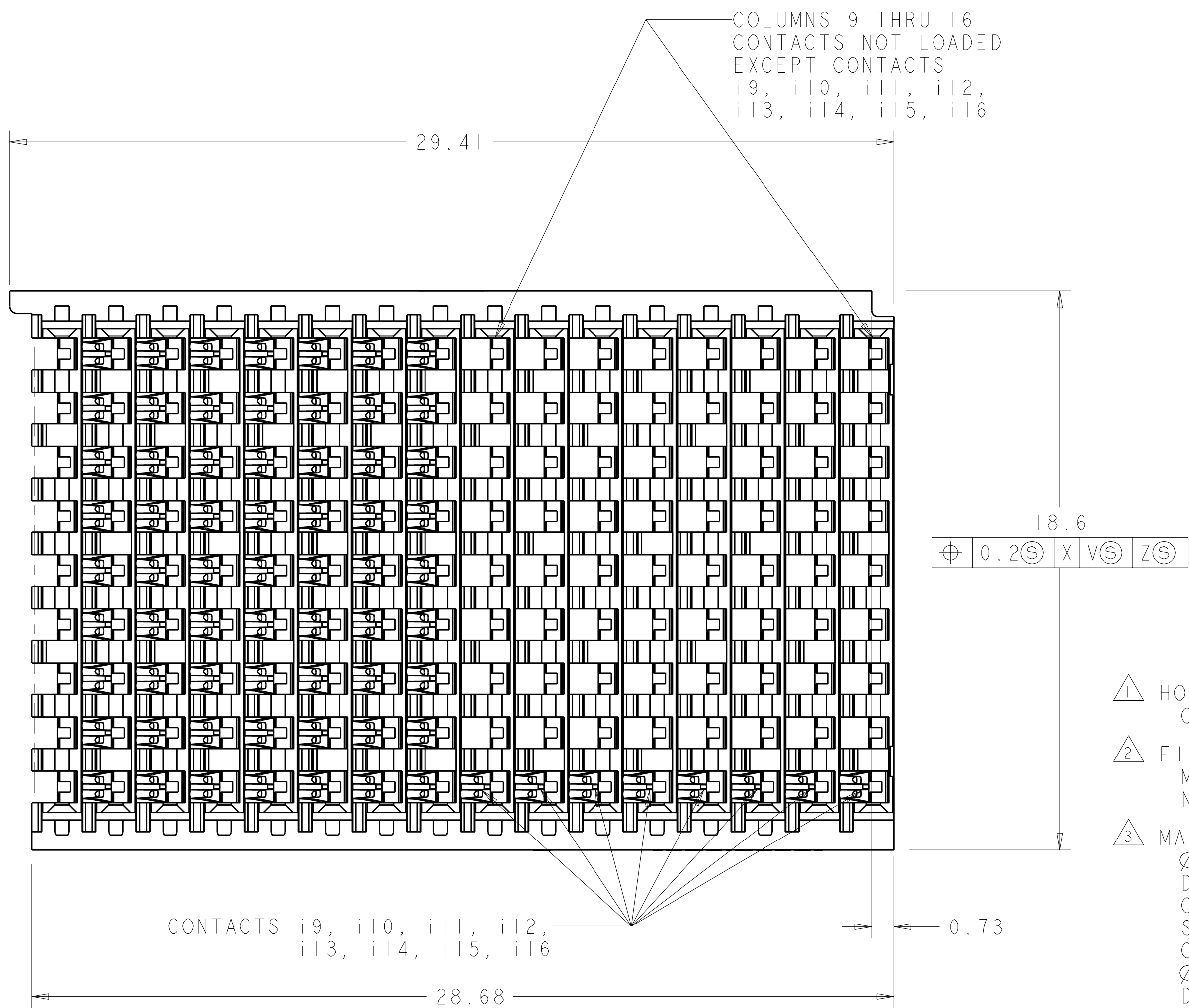




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- Technical drawing of a wafer assembly. The drawing shows a top view of a rectangular assembly with a central label "A" and "LCP-GF30". The assembly consists of a central rectangular block with a series of vertical slots on the left and right sides. The top surface of the block is marked with a series of vertical lines, and the bottom surface is marked with a series of vertical lines. Dimensions are indicated by arrows and text:
- Overall width: 28.27
 - Overall height: 10.5
 - Distance from left edge to center of wafer #8 slot: 10.8 REF
 - Distance from center of wafer #8 slot to right edge: 0.65 REF
 - Distance from left edge to center of wafer #8 slot: 1.15 REF
 - Label "A" is centered on the top surface.
 - Label "LCP-GF30" is centered on the top surface.
 - Label "OF - V -" is located near the top edge.
 - Label "OF WAFER #8 SLOT" is located near the bottom edge.
 - Label "5" is in the top right corner.
 - Label "- X -" is in the bottom right corner.

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